

SoundBonding Application

3DBonding (Patents pending)

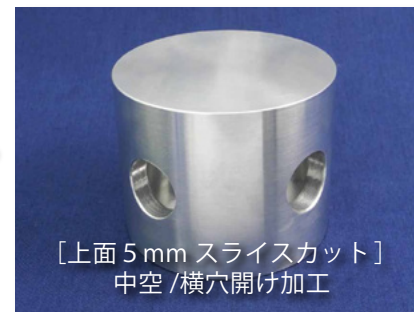
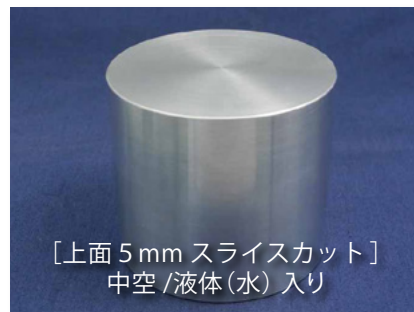
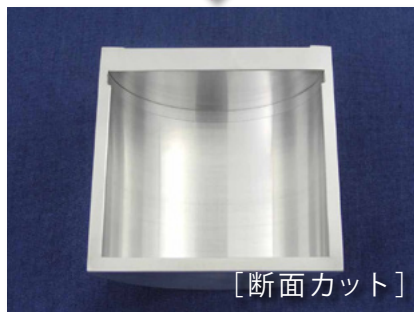
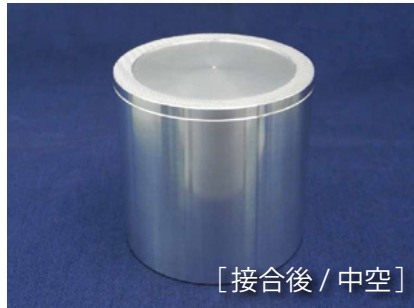
〈各種金属のインゴット合金三次元接合〉



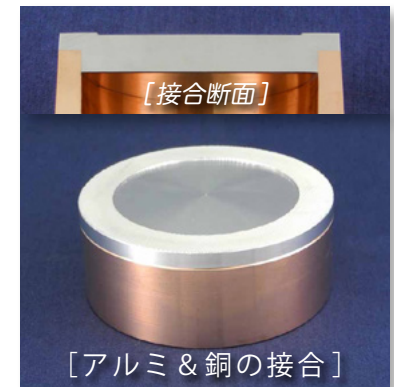
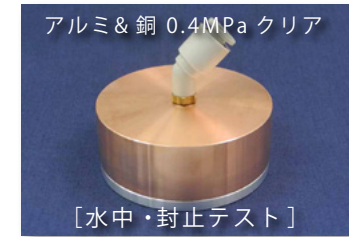
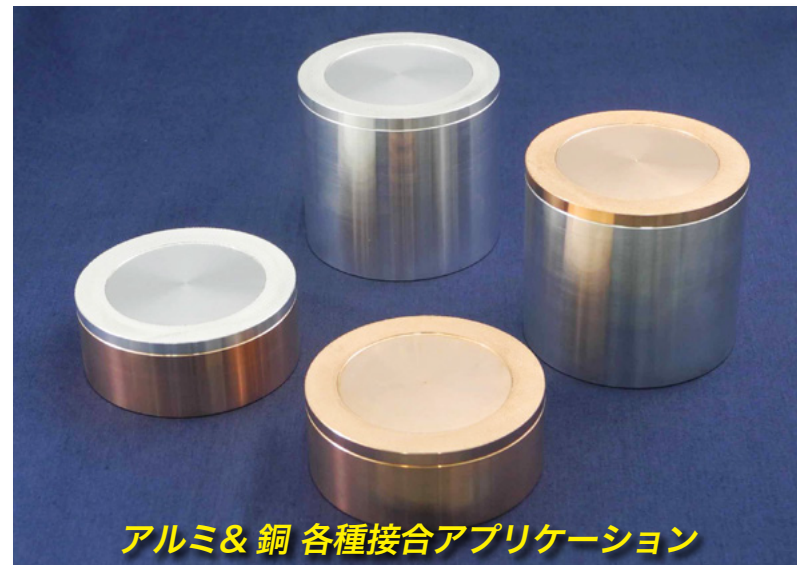
[アルミ材料 A1070]
〈蓋〉 od=54 t=6mm
〈本体〉 od=54 id=48 h=50mm t=3mm



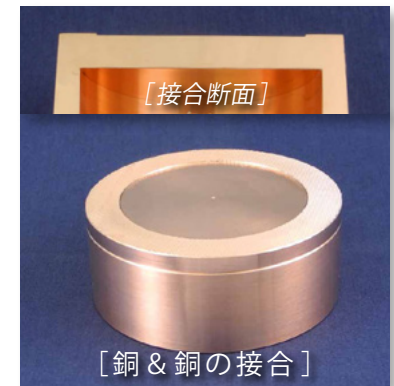
[蓋と本体] の 1 秒以下の瞬間接合 !!



〈接合痕が無い〉



〈合金〉



〈インゴット〉

ULTEX
SoundPower Laboratory